

**Silicon Carbide (SiC)  
 Schottky Diode – EliteSiC,  
 20 A, 650 V, D1,  
 TO-220F-2L**

**FFSPF2065A**

**Description**

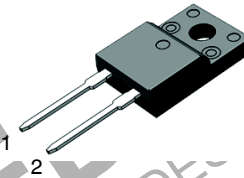
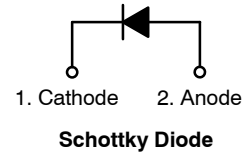
Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

**Features**

- Max Junction Temperature 175°C
- Avalanche Rated 95 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery
- These Devices are Pb-Free and are RoHS Compliant

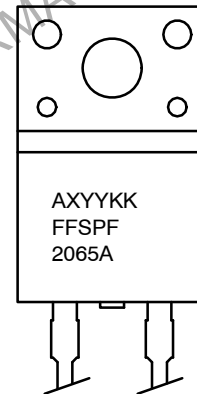
**Applications**

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits



TO-220 FP / TO-220F-2FS  
 CASE 221AS

**MARKING DIAGRAM**



- A = Assembly Plant Code
- XYX = Date Code (Year & Week)
- KK = Lot Traceability Code
- FFSH2065A = Specific Device Code

**ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

# FFSPF2065A

## ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	650	V	
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 1)	95	mJ	
I <sub>F</sub>	Continuous Rectified Forward Current @ T <sub>C</sub> < 67°C	20	A	
	Continuous Rectified Forward Current @ T <sub>C</sub> < 135°C	10		
I <sub>F, Max</sub>	Non-Repetitive Peak Forward Surge Current	T <sub>C</sub> = 25°C, 10 μs	1100	A
		T <sub>C</sub> = 150°C, 10 μs	1000	A
I <sub>F, SM</sub>	Non-Repetitive Forward Surge Current	Half-Sine Pulse, t <sub>p</sub> = 8.3 ms	105	A
I <sub>F, RM</sub>	Repetitive Forward Surge Current	Half-Sine Pulse, t <sub>p</sub> = 8.3 ms	58	A
P <sub>tot</sub>	Power Dissipation	T <sub>C</sub> = 25°C	49	W
		T <sub>C</sub> = 150°C	8.1	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +175	°C	
	TO-220F Mounting Torque, M3 Screw	60	Ncm	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. E<sub>AS</sub> of 95 mJ is based on starting T<sub>J</sub> = 25°C, L = 0.5 mH, I<sub>AS</sub> = 19.5 A, V = 50 V.

## THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction to Case, Max	3.1	°C/W

## ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 20 A, T <sub>C</sub> = 25°C	-	1.5	1.75	V
		I <sub>F</sub> = 20 A, T <sub>C</sub> = 125°C	-	1.6	2.0	
		I <sub>F</sub> = 20 A, T <sub>C</sub> = 175°C	-	1.72	2.4	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 650 V, T <sub>C</sub> = 25°C	-	-	200	μA
		V <sub>R</sub> = 650 V, T <sub>C</sub> = 125°C	-	-	400	
		V <sub>R</sub> = 650 V, T <sub>C</sub> = 175°C	-	-	600	
Q <sub>C</sub>	Total Capacitive Charge	V = 400 V	-	64	-	nC
C	Total Capacitance	V <sub>R</sub> = 1 V, f = 100 kHz	-	1085	-	pF
		V <sub>R</sub> = 200 V, f = 100 kHz	-	117	-	
		V <sub>R</sub> = 400 V, f = 100 kHz	-	88	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## ORDERING INFORMATION

Part Number	Top Marking	Package	Shipping
FFSPF2065A	FFSPF2065A	TO-220 FP / TO-220F-2FS (Pb-Free)	50 Units / Tube

# FFSPF2065A

## TYPICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

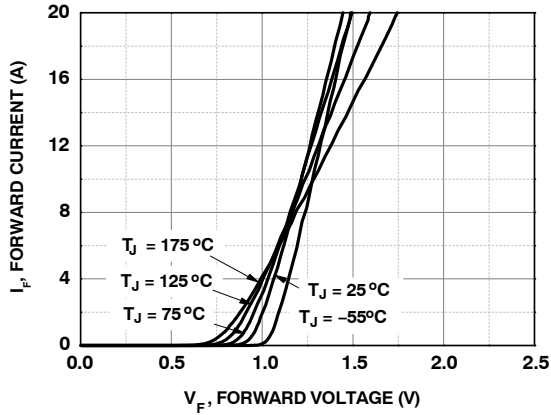


Figure 1. Forward Characteristics

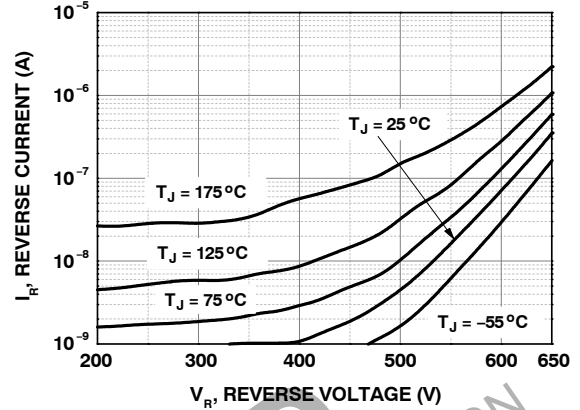


Figure 2. Reverse Characteristics

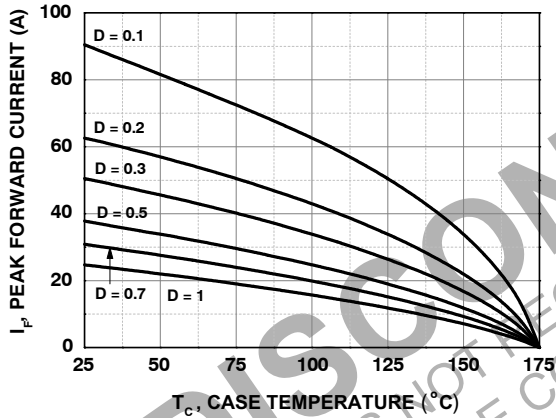


Figure 3. Current Derating

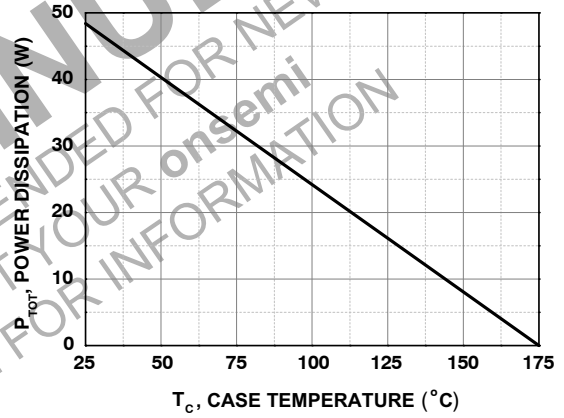


Figure 4. Power Derating

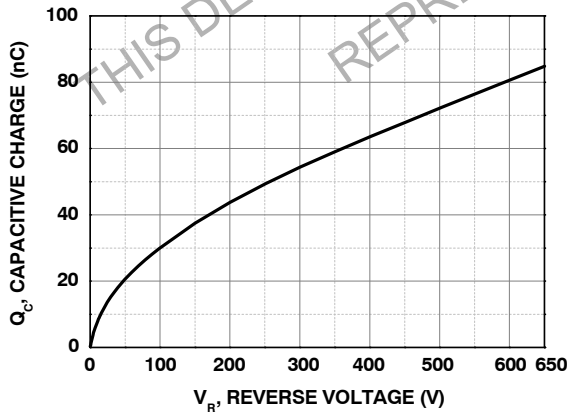


Figure 5. Capacitive Charge vs. Reverse Voltage

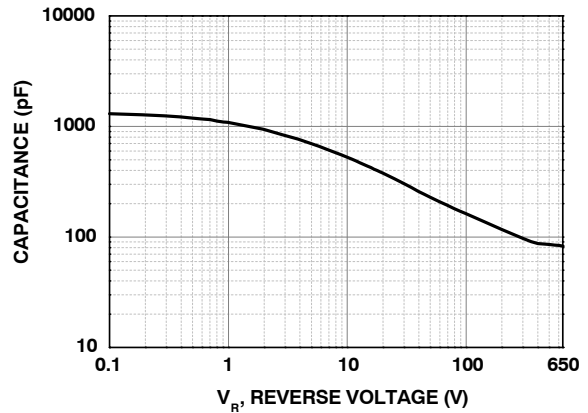


Figure 6. Capacitance vs. Reverse Voltage

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## TYPICAL CHARACTERISTICS

( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)

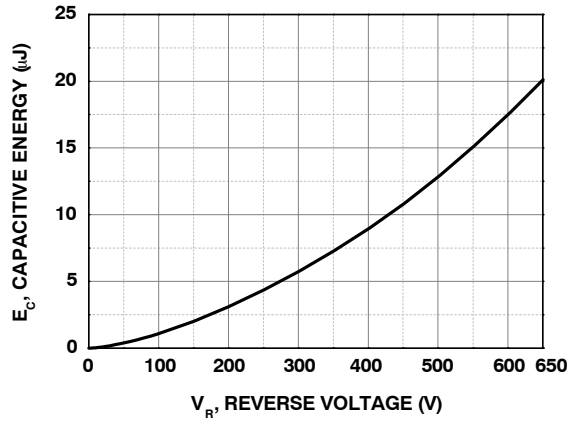


Figure 7. Capacitance Stored Energy

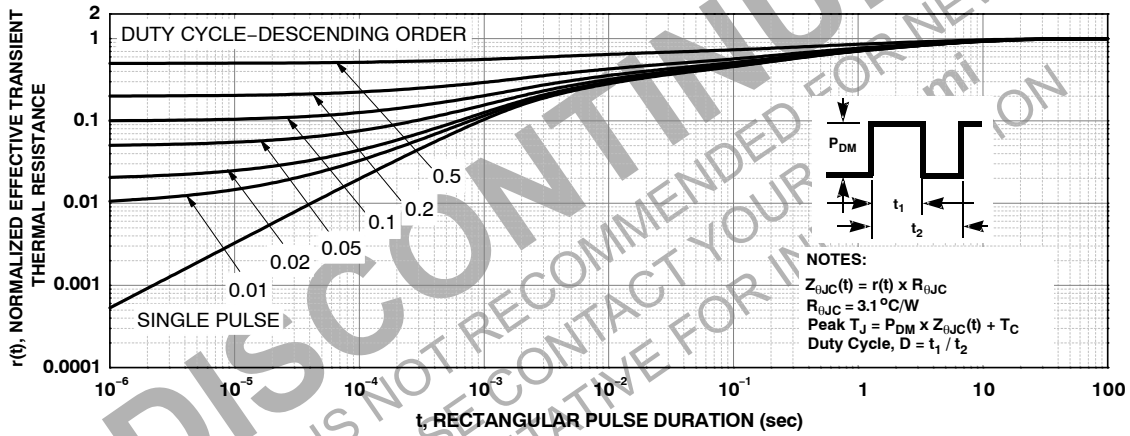


Figure 8. Junction-to-Case Transient Thermal Response Curve

TEST CIRCUIT AND WAVEFORMS

$L = 0.5 \text{ mH}$   
 $R < 0.1 \ \Omega$   
 $V_{DD} = 50 \text{ V}$   
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)} / (V_{R(AVL)} - V_{DD})]$   
 $Q1 = \text{IGBT (} BV_{CES} > \text{DUT } V_{R(AVL)})$

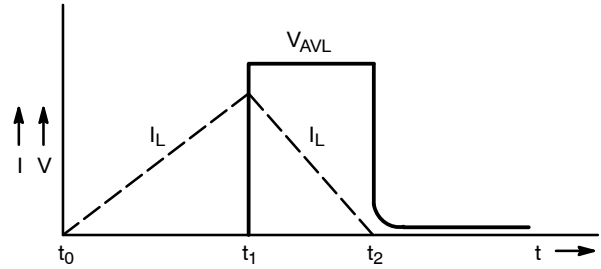
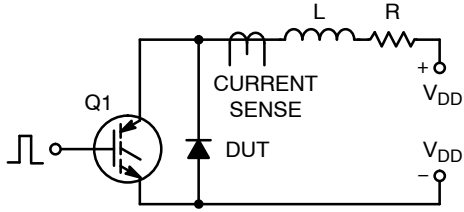


Figure 9. Unclamped Inductive Switching Test Circuit & Waveform

DISCONTINUED

THIS DEVICE IS NOT RECOMMENDED FOR NEW DESIGN  
PLEASE CONTACT YOUR onsemi  
REPRESENTATIVE FOR INFORMATION

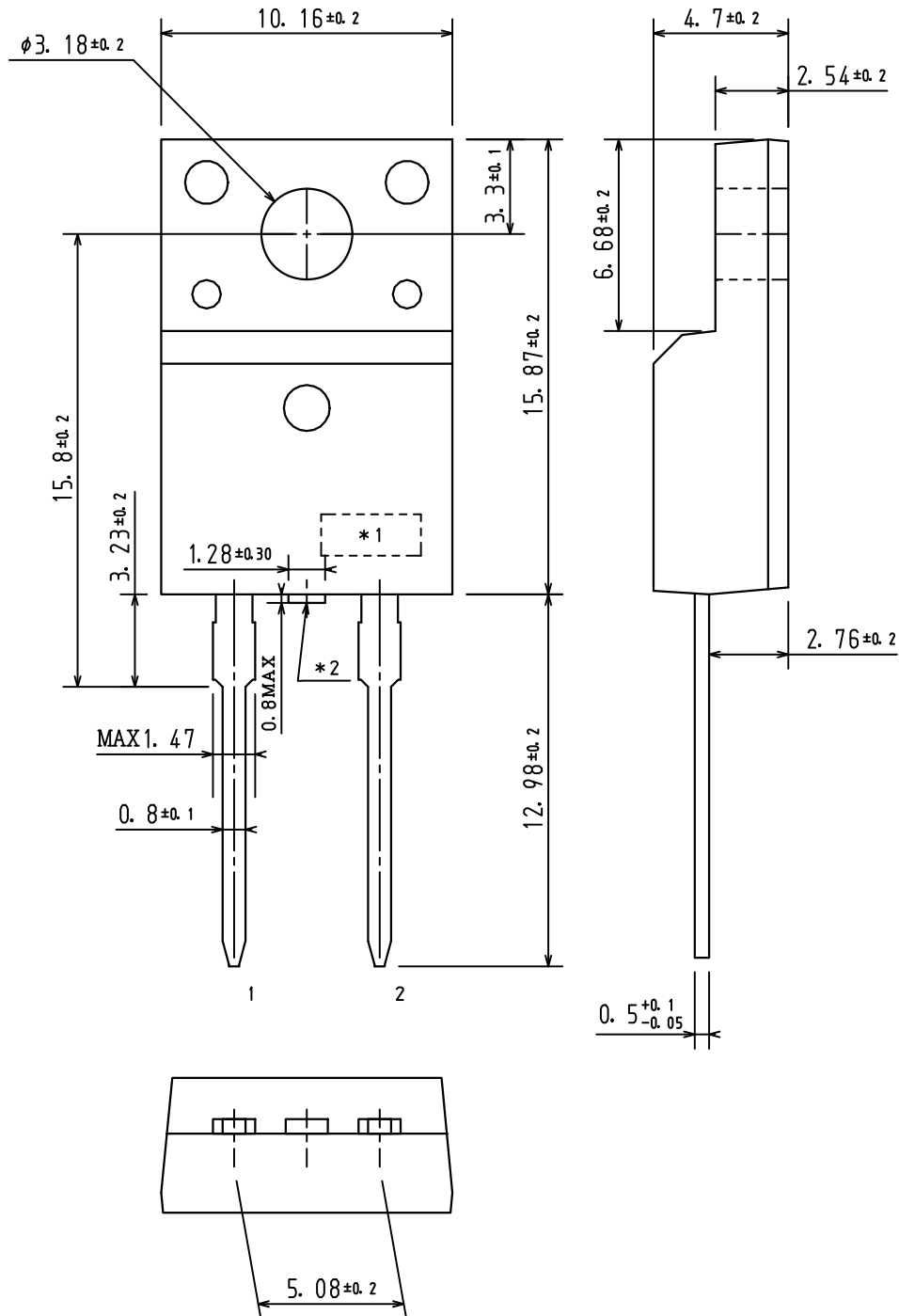
**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

ON Semiconductor®



**TO-220 Fullpack, 2-Lead / TO-220F-2FS**  
**CASE 221AS**  
**ISSUE O**

DATE 29 FEB 2012



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<b>DESCRIPTION:</b>	<b>TO-220 FULLPACK, 2-LEAD / TO-220F-2FS</b>	<b>PAGE 1 OF 1</b>

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